

RECOMMENDED PCB LAYOUT

- NOTE:
- MATERIAL :  
BASE : HIGH TEMPERATURE THERMOPLASTIC UL94V-0,  
TERMINAL:COPPER ALLOY,THICKNESS = 0.30 mm
  - PLATING:  
CONTACT:GOLD OVER 50u" MIN NICKEL UNDERPLATE  
SOLDER TAIL:150u"MIN MISTY TIN 50u" MIN NICKEL UNDERPLATE  
GOLD SPECIFICATION:SEE TABLE
  - ELECTRONICAL SPECIFICATION:  
CURRENT RATING: 1.5 AMPERE PER CONTACT  
CONTACT RESISTANCE: 30 MILLIOHMS MAX.  
INSULATION RESISTANCE: 1000 MEGOHMS MIN.  
DIELECTRIC WITHSTANDING VOLTAGE: 500 VDC.  
OPERATING TEMPERATURE: -40°C~+85°C
  - MEETS THE REQUIREMENTS OF DIRECTIVE 2002/95/EC OF THE EUROPEAN PARLIAMENT AND OF THE COUNCIL OF 27 JANUARY 2003 ON THE RESTRICTION OF THE USE OF CERTAIN HAZARDOUS SUBSTANCES IN ELECTRICAL AND ELECTRONIC EQUIPMENT(ROHS)

RoHS Compliant

TOLERANCES ARE

**MORETHANALL**  
PCB CONNECTORS  
Cable ASSEMBLIES

煜倫股份有限公司

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DRAWING BY CY

CHECKED BY GENIUS

UNIT/mm

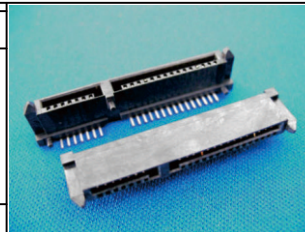
SCALE 1:1

DATE

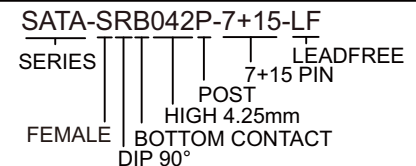
SIZE A4

PJECTION

X. ±  
.X ±  
.XX ±  
.XXX ±  
ANG ±



ORDER INFORMATION



DESCRIPTION: SATA 22P SOCKET 無墊高DIP三柱型